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Specification

SSC-STW8T16C

SSC-STW8T16C

March 2013

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STW8T16C

Description

This surface-mount LED comes in standard package dimension. It has a substrate made up of a molded plastic reflector sitting on top of a lead frame. The die is attached within the reflector cavity and the cavity is encapsulated by silicone.

The package design coupled with careful selection of component materials allow these products to perform with high reliability.



STW8T16C

Features

- Lead Frame type LED PKG size: 5.0*5.0 thickness 1.0mm
- White colored SMT package
- Pb-free Reflow Soldering Application
- RoHS compliant

Applications

- Interior lighting
- General lighting
- Indoor and out door displays
- Architectural / Decorative lighting

SSC-STW8T16C

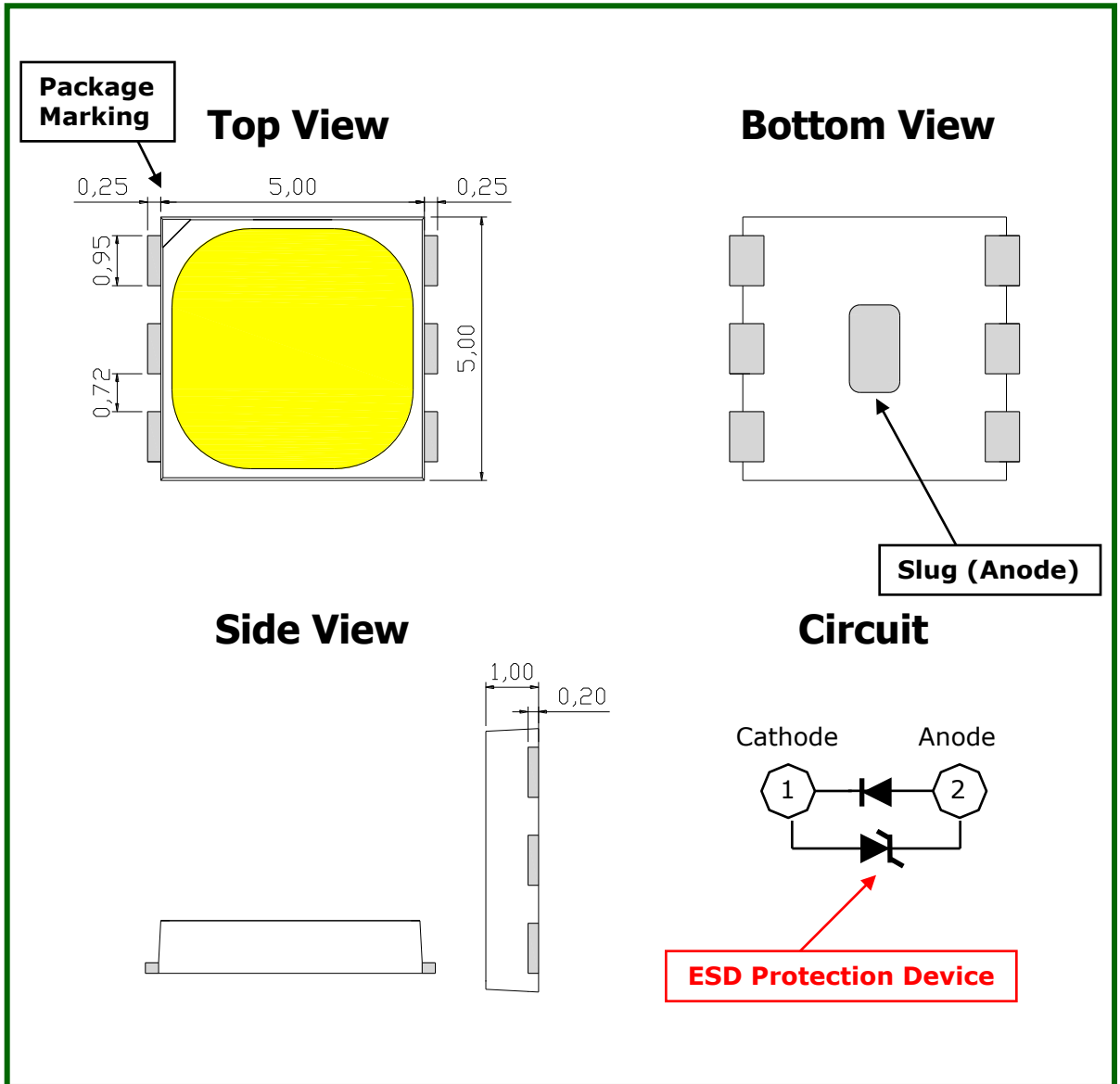
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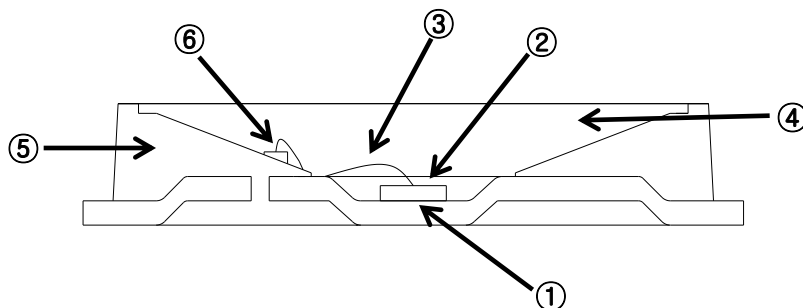
1. Outline dimensions of STW8T16C



Notes :

- [1] All dimensions are in millimeters.
- [2] Scale : none
- [3] Undefined tolerance is $\pm 0.1\text{mm}$

Material Structure



Parts No.	Name	Description	Materials
①	LEAD FRAME	Metal	Copper Alloy (Silver Plated)
②	Chip Source	Blue LED	GaN on Sapphire
③	Wire	Metal	Gold Wire
④	Encapsulation	Silicone	+Phosphor
⑤	Body	Thermo Plastic	Heat-resistant Polymer
⑥	Zener Diode	Si	-

2. Characteristics of STW8T16C

1) Electro-Optical characteristics at 65mA

(Ta=25°C, RH30%)

Parameter	Symbol	Value			Unit
		Min	Typ	Max	
Forward Voltage	V_F	2.8	-	3.3	V
Reverse Voltage	V_R	-	0.9	1.2	V
Luminous Intensity* ^[1] (3,700~8,200 K)	I_V	-	9.0 (27.5)	-	cd (lm)
Luminous Intensity* ^[1] (2,600~3,700 K)	I_V	-	8.2 (24.6)	-	cd (lm)
Correlated Color Temperature	CCT	2,600	-	8,200	K
Viewing Angle ^[2]	$2\theta_{1/2}$	-	120	-	-
Color Rendering Index*	Ra	80	-	90	-
Thermal resistance (J to S)	$R\theta_{J-S}$	-	14	-	K/W

2) Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I_F	100	mA
Power Dissipation* ^[3]	P_d	315	mW
Junction Temperature	T_j	125	°C
Operating Temperature	T_{opr}	-40 ~ +85	°C
Storage Temperature	T_{stg}	-40 ~ +100	°C
ESD (HBM)		±5,000V HBM	V

Notes :

All measurements were made under the standardized environment of SSC.

LED's properties might be different from suggested values like above and below tables if operation condition will be exceeded our parameter range.

[1] The luminous intensity I_V was measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.

[2] $2\theta_{1/2}$ is the off-axis where the luminous intensity is 1/2 of the peak intensity.

[3] Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product.

* Tolerance : V_F : ±0.1V, I_V : ±7%, Ra : ±2, x, y : ±0.007

SSC-STW8T16C

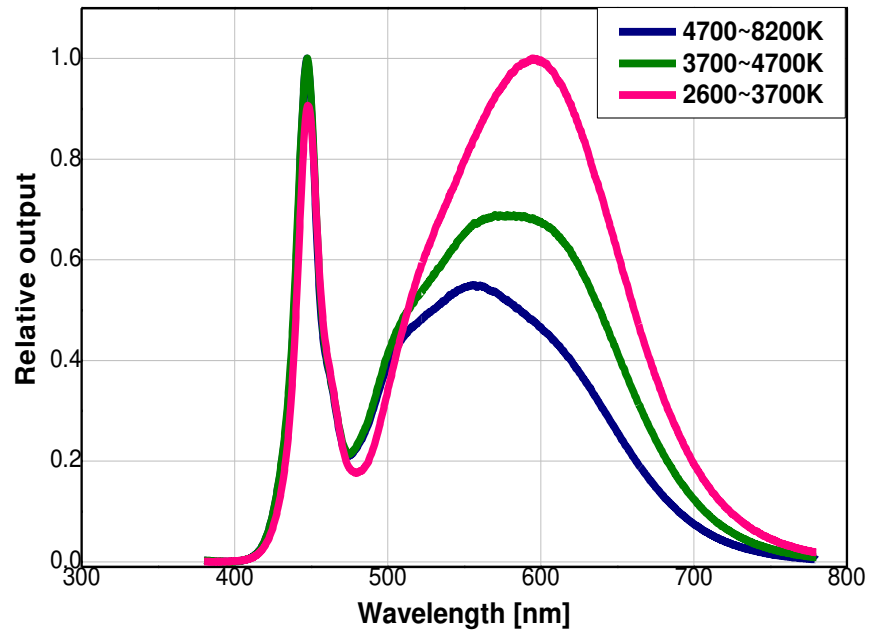
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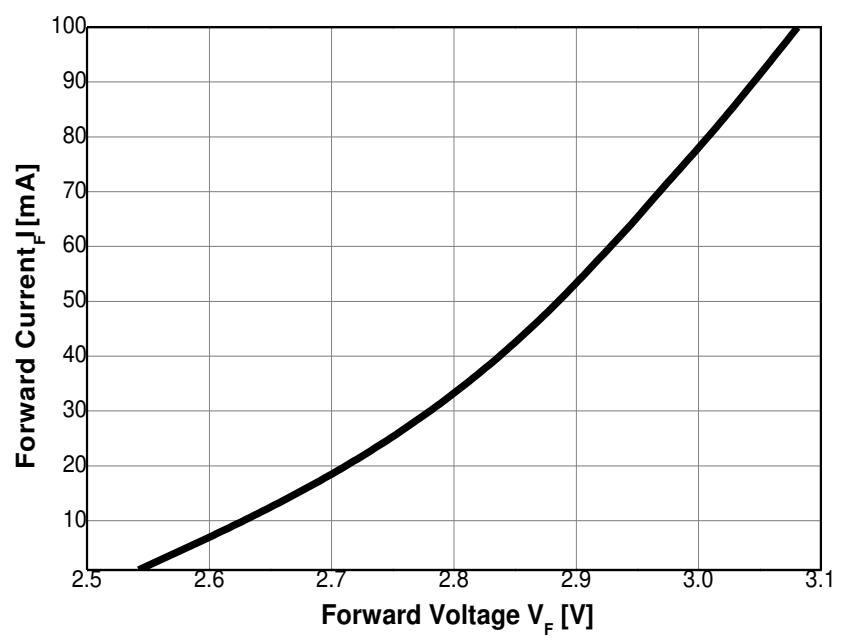
3. Characteristic diagrams

1) Spectrum data

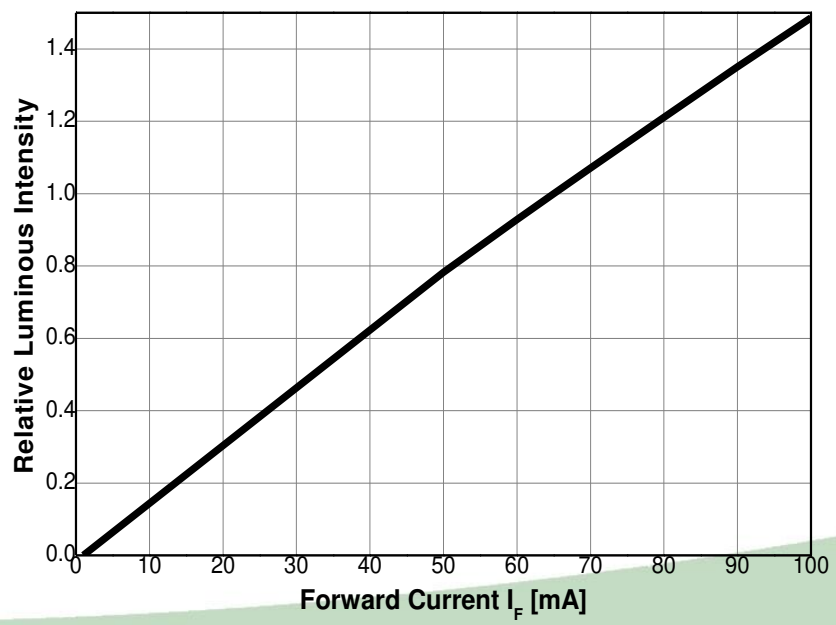
(IF=65mA, Ta=25°C, RH30%)



2) Forward Voltage vs. Forward Current, Ta=25°C



3) Forward Current vs. Relative Luminous Intensity, Ta=25°C

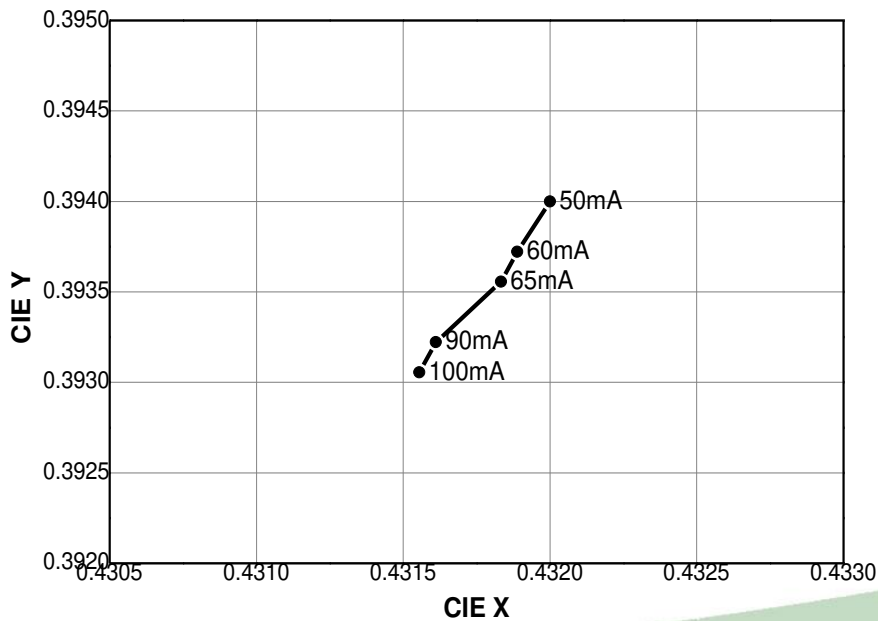
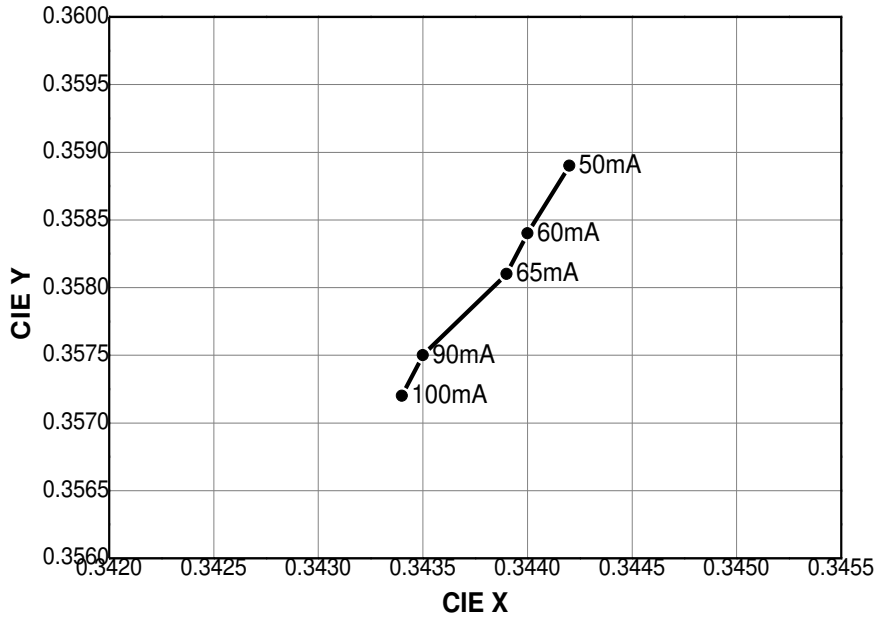


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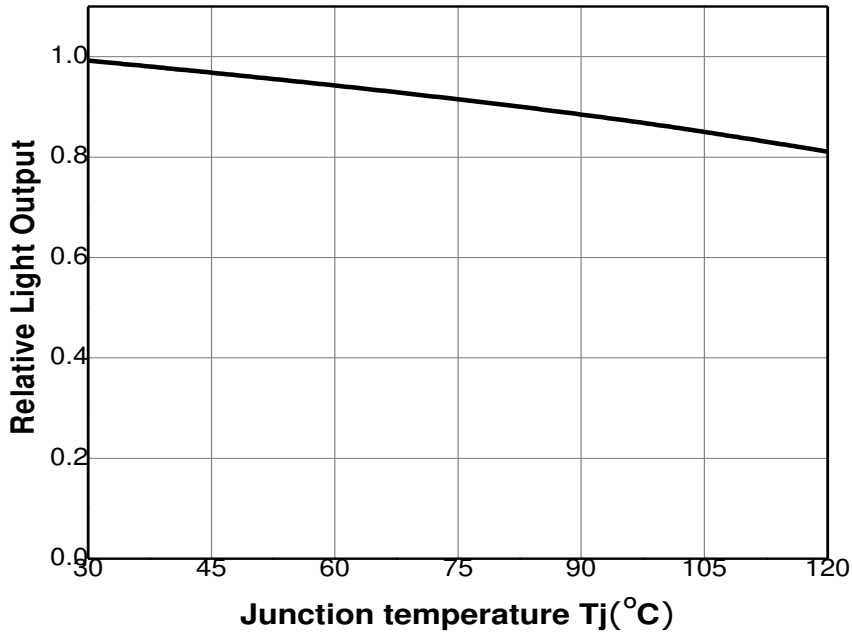
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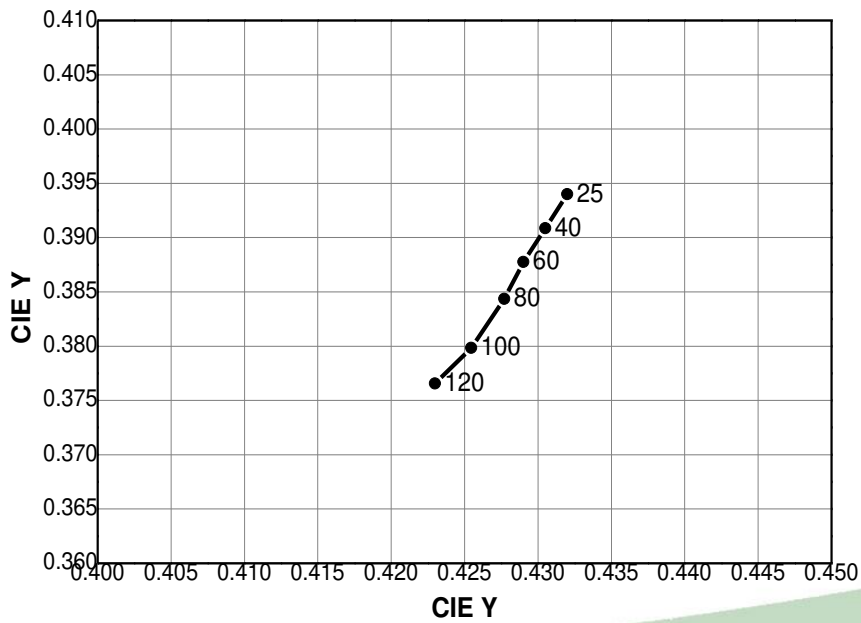
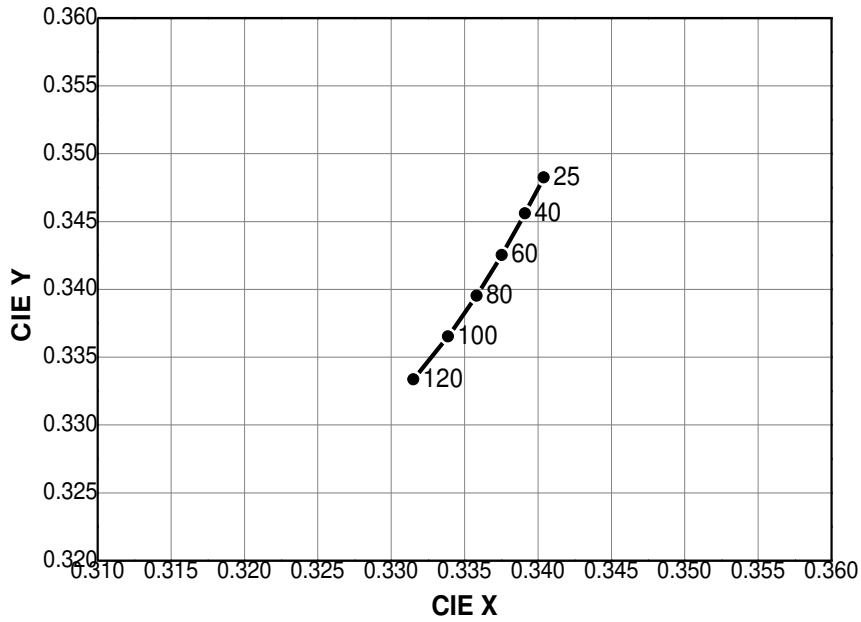
4) Chromaticity Coordinate vs. Forward Current, Ta=25°C



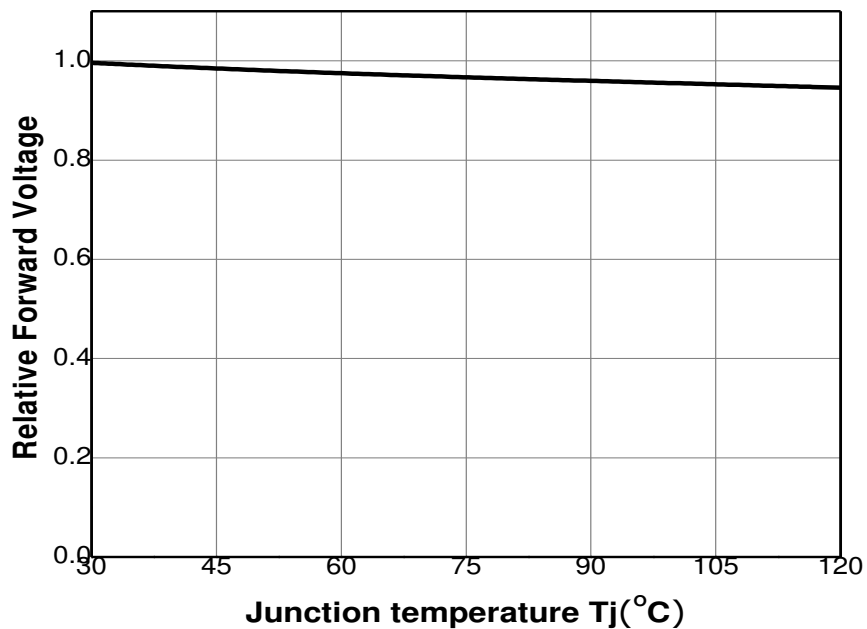
5) Relative Luminous Intensity vs. Junction Temperature, IF=65mA



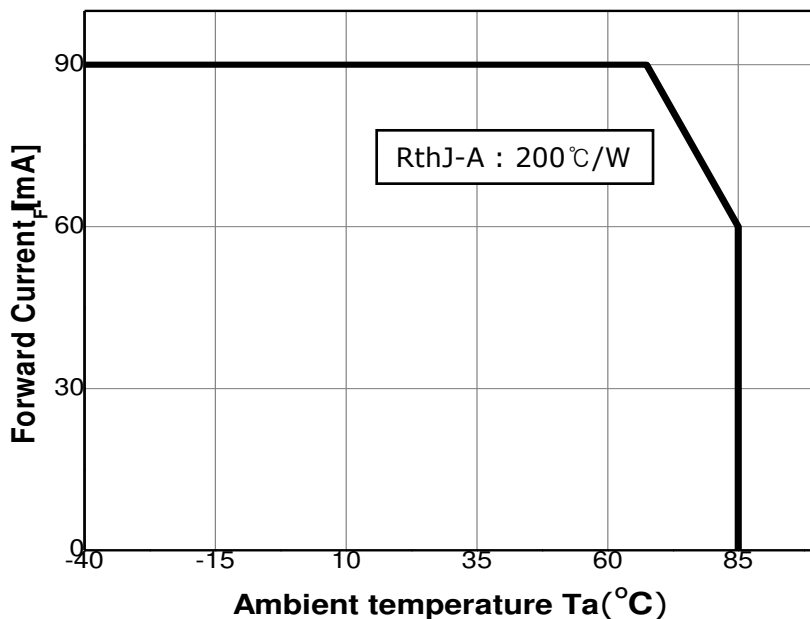
6) Chromaticity Coordinate vs. Junction Temperature, IF=65mA



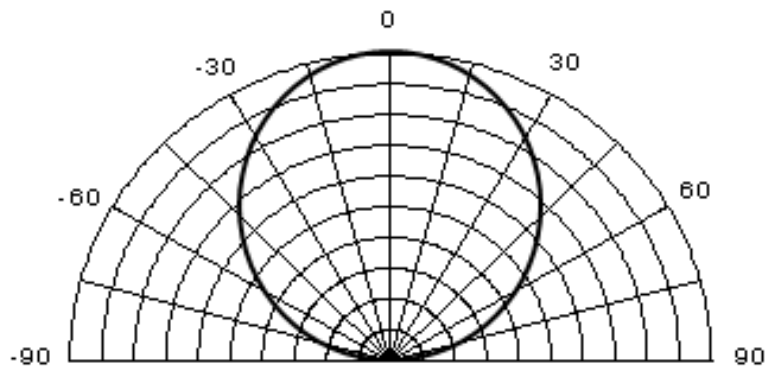
7) Ambient Temperature vs. Allowable Forward Current, $I_F=65\text{mA}$



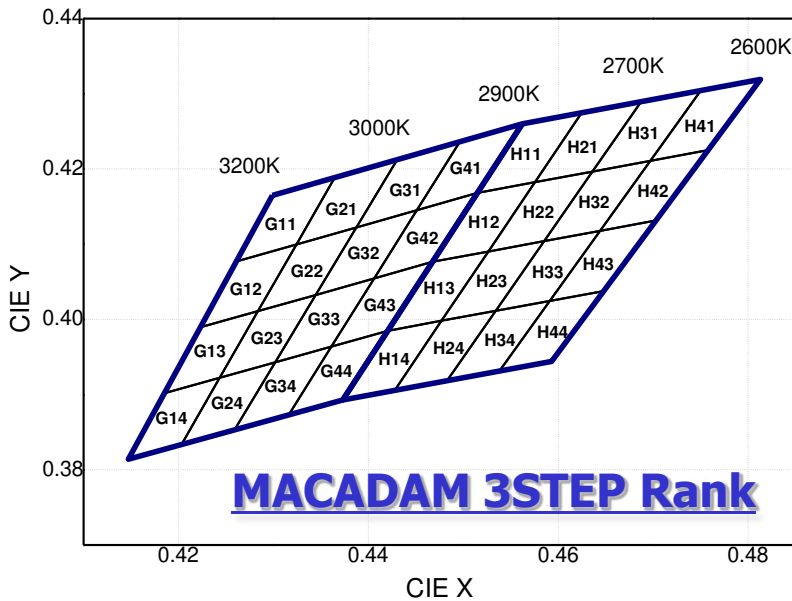
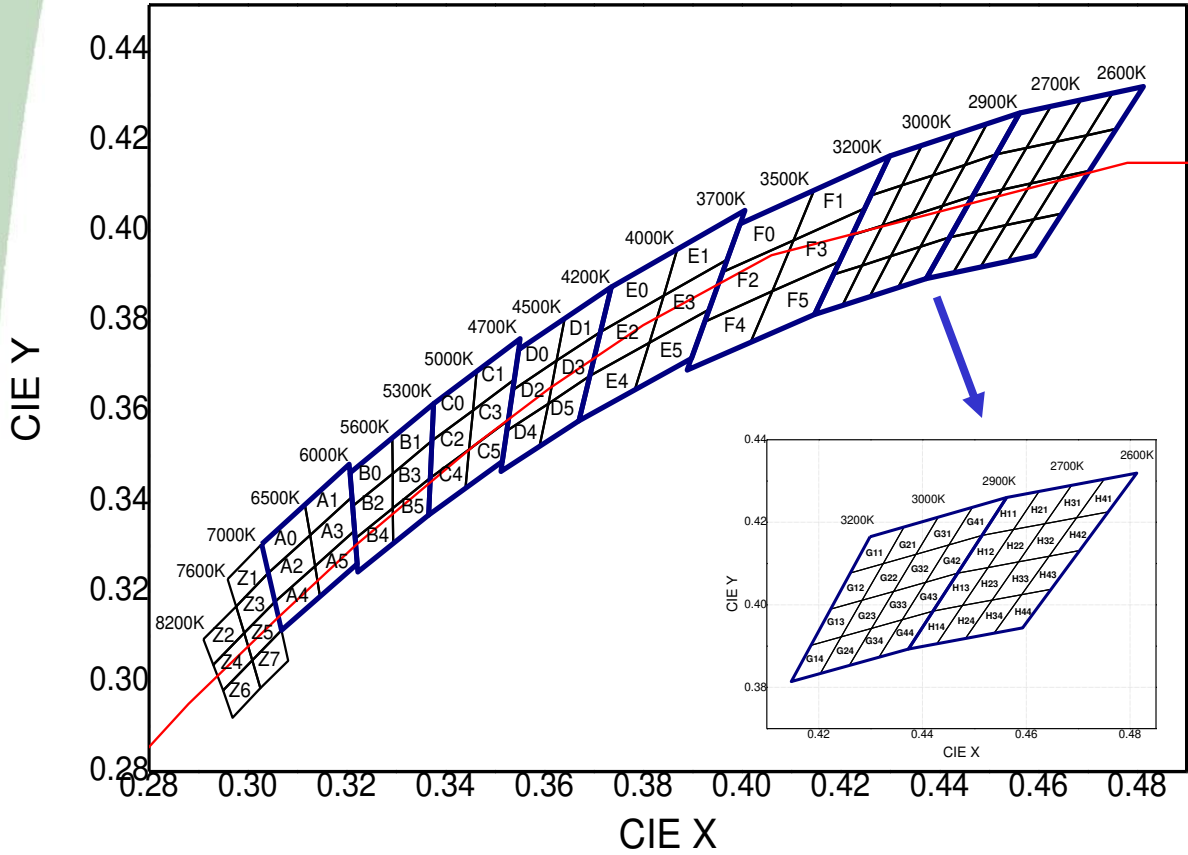
8) Ambient Temperature vs. Maximum Forward Current



9) Viewing angle, $T_a=25^\circ\text{C}$



4. Color & Binning



* Apply the Energy Star binning(3200~7000K) & MACADAM 3 Step binning (just, 2600~3200K)

* Measurement Uncertainty of the Color Coordinates : ± 0.007

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4. Color & Binning

● COLOR RANK

<IF=65mA, Ta=25℃>

Z1		Z2		Z3	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.2959	0.3227	0.291	0.3093	0.2976	0.3166
0.2976	0.3166	0.293	0.3037	0.2993	0.3107
0.3041	0.324	0.2993	0.3107	0.3055	0.3177
0.3028	0.3304	0.2976	0.3166	0.3041	0.324
Z4		Z5		Z6	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.293	0.3037	0.2993	0.3107	0.295	0.298
0.295	0.298	0.3009	0.3047	0.2969	0.2919
0.3009	0.3047	0.3068	0.3113	0.3025	0.2985
0.2993	0.3107	0.3055	0.3177	0.3009	0.3047
Z7					
CIE X	CIE Y				
0.3009	0.3047				
0.3025	0.2985				
0.3082	0.3046				
0.3068	0.3113				

4. Color & Binning

● COLOR RANK

<IF=65mA, Ta=25℃>

A0		A1		A2	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3028	0.3304	0.3115	0.3393	0.3041	0.324
0.3041	0.324	0.3126	0.3324	0.3055	0.3177
0.3126	0.3324	0.321	0.3408	0.3136	0.3256
0.3115	0.3393	0.3205	0.3481	0.3126	0.3324
A3		A4		A5	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3126	0.3324	0.3055	0.3177	0.3136	0.3256
0.3136	0.3256	0.3068	0.3113	0.3146	0.3187
0.3216	0.3334	0.3146	0.3187	0.3221	0.3261
0.321	0.3408	0.3136	0.3256	0.3216	0.3334
B0		B1		B2	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3207	0.3462	0.3292	0.3539	0.3212	0.3389
0.3212	0.3389	0.3293	0.3461	0.3217	0.3316
0.3293	0.3461	0.3373	0.3534	0.3293	0.3384
0.3292	0.3539	0.3376	0.3616	0.3293	0.3461
B3		B4		B5	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3293	0.3461	0.3217	0.3316	0.3293	0.3384
0.3293	0.3384	0.3222	0.3243	0.3294	0.3306
0.3369	0.3451	0.3294	0.3306	0.3366	0.3369
0.3373	0.3534	0.3293	0.3384	0.3369	0.3451

4. Color & Binning

● COLOR RANK

<IF=65mA, Ta=25℃>

C0		C1		C2	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3376	0.3616	0.3463	0.3687	0.3373	0.3534
0.3373	0.3534	0.3456	0.3601	0.3369	0.3451
0.3456	0.3601	0.3539	0.3669	0.3448	0.3514
0.3463	0.3687	0.3552	0.376	0.3456	0.3601
C3		C4		C5	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3456	0.3601	0.3369	0.3451	0.3448	0.3514
0.3448	0.3514	0.3366	0.3369	0.344	0.3428
0.3526	0.3578	0.344	0.3428	0.3514	0.3487
0.3539	0.3669	0.3448	0.3514	0.3526	0.3578
D0		D1		D2	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3548	0.3736	0.3641	0.3804	0.3536	0.3646
0.3536	0.3646	0.3625	0.3711	0.3523	0.3555
0.3625	0.3711	0.3714	0.3775	0.3608	0.3616
0.3641	0.3804	0.3736	0.3874	0.3625	0.3711
D3		D4		D5	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3625	0.3711	0.3523	0.3555	0.3608	0.3616
0.3608	0.3616	0.3511	0.3465	0.359	0.3521
0.3692	0.3677	0.359	0.3521	0.367	0.3578
0.3714	0.3775	0.3608	0.3616	0.3692	0.3677

4. Color & Binning

● COLOR RANK

<IF=65mA, Ta=25℃>

E0		E1		E2	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3736	0.3874	0.3869	0.3958	0.3714	0.3775
0.3714	0.3775	0.3842	0.3855	0.3692	0.3677
0.3842	0.3855	0.397	0.3935	0.3813	0.3751
0.3869	0.3958	0.4006	0.4044	0.3842	0.3855
E3		E4		E5	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3842	0.3855	0.3692	0.3677	0.3813	0.3751
0.3813	0.3751	0.367	0.3578	0.3783	0.3646
0.3934	0.3825	0.3783	0.3646	0.3898	0.3716
0.397	0.3935	0.3813	0.3751	0.3934	0.3825
F0		F1		F2	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3996	0.4015	0.4146	0.4089	0.396	0.3907
0.396	0.3907	0.4104	0.3978	0.3925	0.3798
0.4104	0.3978	0.4248	0.4048	0.4062	0.3865
0.4146	0.4089	0.4299	0.4165	0.4104	0.3978
F3		F4		F5	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4104	0.3978	0.3925	0.3798	0.4062	0.3865
0.4062	0.3865	0.3889	0.369	0.4017	0.3751
0.4198	0.3931	0.4017	0.3751	0.4147	0.3814
0.4248	0.4048	0.4062	0.3865	0.4198	0.3931

4. Color & Binning

● COLOR RANK

<IF=65mA, Ta=25℃>

G11		G21		G31		G41	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4365	0.4189	0.4430	0.4212	0.4496	0.4236	0.4562	0.4260
0.4324	0.4100	0.4387	0.4122	0.4451	0.4145	0.4515	0.4168
0.4261	0.4077	0.4324	0.4100	0.4387	0.4122	0.4451	0.4145
0.4299	0.4165	0.4365	0.4189	0.4430	0.4212	0.4496	0.4236
G12		G22		G32		G42	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4324	0.4100	0.4387	0.4122	0.4451	0.4145	0.4515	0.4168
0.4284	0.4011	0.4345	0.4033	0.4406	0.4055	0.4468	0.4077
0.4223	0.3990	0.4284	0.4011	0.4345	0.4033	0.4406	0.4055
0.4261	0.4077	0.4324	0.4100	0.4387	0.4122	0.4451	0.4145
G13		G23		G33		G43	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4284	0.4011	0.4345	0.4033	0.4406	0.4055	0.4468	0.4077
0.4243	0.3922	0.4302	0.3943	0.4361	0.3964	0.4420	0.3985
0.4185	0.3902	0.4243	0.3922	0.4302	0.3943	0.4361	0.3964
0.4223	0.3990	0.4284	0.4011	0.4345	0.4033	0.4406	0.4055
G14		G24		G34		G44	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4243	0.3922	0.4302	0.3943	0.4361	0.3964	0.4316	0.3873
0.4203	0.3834	0.4259	0.3853	0.4259	0.3853	0.4302	0.3943
0.4147	0.3814	0.4203	0.3834	0.4420	0.3985	0.4373	0.3893
0.4185	0.3902	0.4243	0.3922	0.4316	0.3873	0.4361	0.3964

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* Measurement Uncertainty of the Color Coordinates : ± 0.007

서식번호 : SSC-QP-7-07-12 (Rev.01)

4. Color & Binning

● COLOR RANK

<IF=65mA, Ta=25℃>

H11		H21		H31		H41	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4625	0.4275	0.4687	0.4289	0.4750	0.4304	0.4810	0.4319
0.4575	0.4182	0.4636	0.4197	0.4697	0.4211	0.4758	0.4225
0.4515	0.4168	0.4575	0.4182	0.4636	0.4197	0.4697	0.4211
0.4562	0.4260	0.4625	0.4275	0.4687	0.4289	0.4750	0.4304
H12		H22		H32		H42	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4575	0.4182	0.4636	0.4197	0.4697	0.4211	0.4758	0.4225
0.4526	0.4090	0.4585	0.4104	0.4644	0.4118	0.4703	0.4132
0.4468	0.4077	0.4526	0.4090	0.4585	0.4104	0.4644	0.4118
0.4515	0.4168	0.4575	0.4182	0.4636	0.4197	0.4697	0.4211
H13		H23		H33		H43	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4526	0.4090	0.4585	0.4104	0.4644	0.4118	0.4703	0.4132
0.4477	0.3998	0.4534	0.4012	0.4591	0.4025	0.4648	0.4038
0.4420	0.3985	0.4477	0.3998	0.4534	0.4012	0.4591	0.4025
0.4468	0.4077	0.4526	0.4090	0.4585	0.4104	0.4644	0.4118
H14		H24		H34		H44	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4477	0.3998	0.4534	0.4012	0.4591	0.4025	0.4648	0.4038
0.4428	0.3906	0.4483	0.3919	0.4538	0.3932	0.4593	0.3944
0.4373	0.3893	0.4428	0.3906	0.4483	0.3919	0.4538	0.3932
0.4420	0.3985	0.4477	0.3998	0.4534	0.4012	0.4591	0.4025

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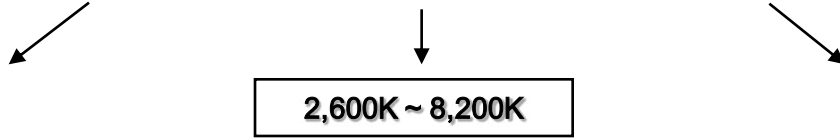
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* Measurement Uncertainty of the Color Coordinates : ± 0.007

서식번호 : SSC-QP-7-07-12 (Rev.01)

5. Bin Code Description

Bin Code		
Luminous Intensity [mcd]	Color Rank	Forward Voltage [V]
R0	A1	Z1



Luminous Intensity [mcd] *[1] @ $I_F = 65\text{mA}$			Flux *[2] [lm]
RANK	Min.	Max.	Typ.
Q0	7000	8000	23
R0	8000	9000	26.8
S0	9000	10000	29.5
T0	10000	11000	31.8

Color Rank @ $I_F = 65\text{mA}$
Z~H

Forward Voltage [V] @ $I_F = 65\text{mA}$		
RANK	Min.	Max.
Y2	2.8	2.9
Y3	2.9	3.0
Z1	3.0	3.1
Z2	3.1	3.2
Z3	3.2	3.3

Available ranks
 Not yet available ranks

CCT	CIE	IV Rank			
7000~8200K	Z	Q0	R0	S0	T0
6000~7000K	A	Q0	R0	S0	T0
5300~6000K	B	Q0	R0	S0	T0
4700~5300K	C	Q0	R0	S0	T0
4200~4700K	D	Q0	R0	S0	T0
3700~4200K	E	Q0	R0	S0	T0
3200~3700K	F	Q0	R0	S0	T0
2900~3200K	G	Q0	R0	S0	T0
2600~2900K	H	Q0	R0	S0	T0

***Notes :**

All measurements were made under the standardized environment of SSC.
 In order to ensure availability, single color rank will not be orderable.

[1] SSC sort the LED package according to the luminous intensity IV.

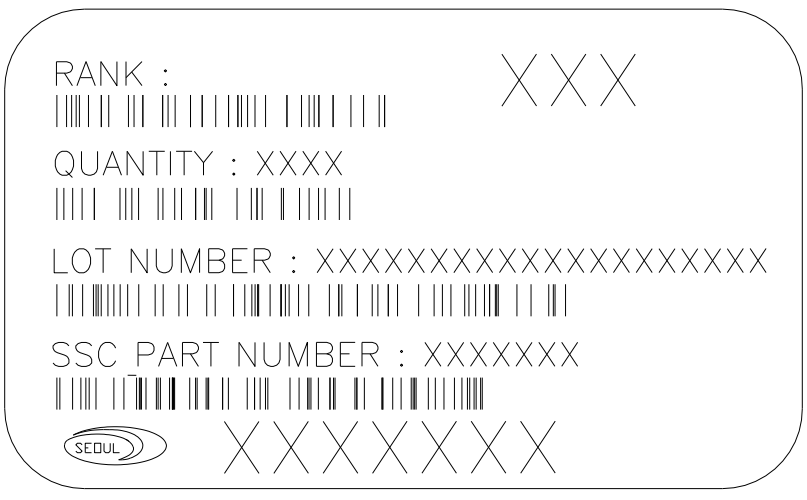
[2] The lumen table is only for reference.

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6. Labeling



Full code form :

X₁X₂-X₃X₄-X₅-X₆X₇-X₈

- X₁ : Company
- X₂ : Kind of LED
- X₃X₄ : CRI Group
- X₅ : Package series
- X₆X₇ : Characteristic code
- X₈ : Version

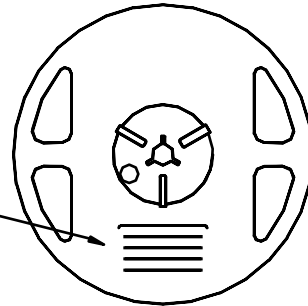
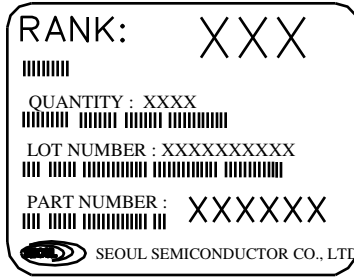
Rank

#1#2#3

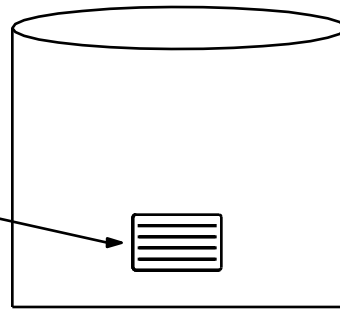
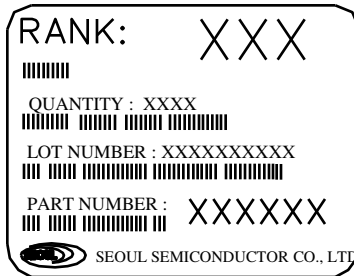
- #1 : Luminous Intensity : IV
- #2 : Color coordinates : x, y
- #3 : Forward Voltage : V_F

7. Packing

Reel



Aluminum Vinyl Bag

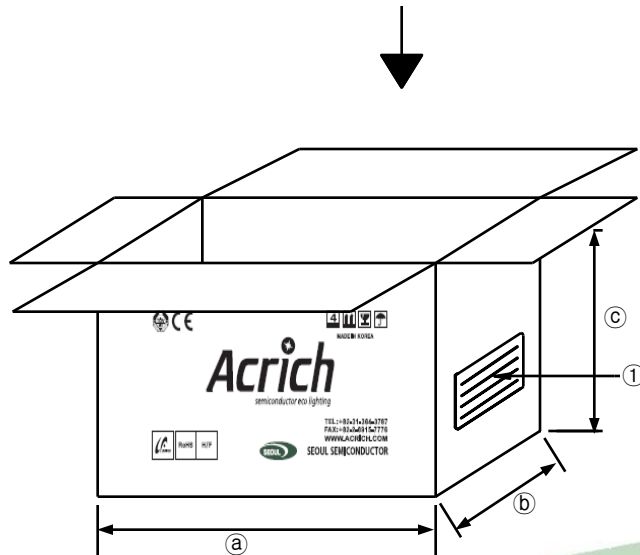
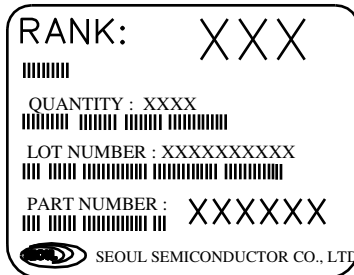


Outer Box Structure

Material : Paper(SW3B(B))

Type	SIZE[mm]		
	a	b	c
7inch	245	220	102
	245	220	142

① SIDE

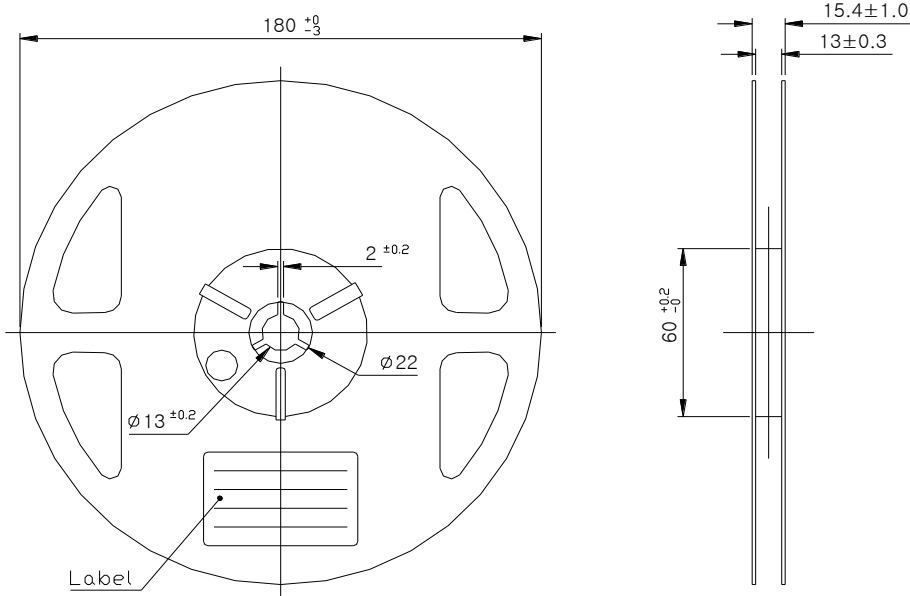
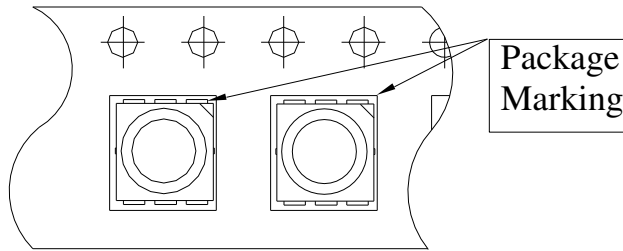
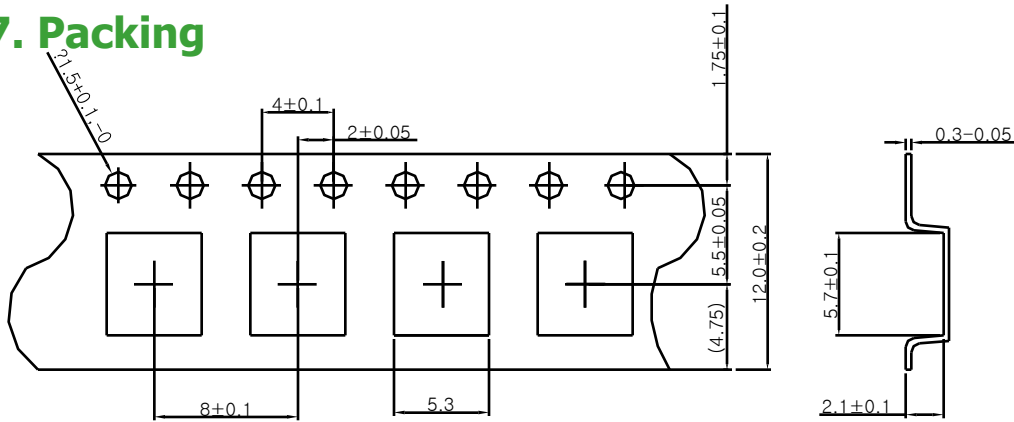


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7. Packing



(Tolerance: ±0.2, Unit: mm)

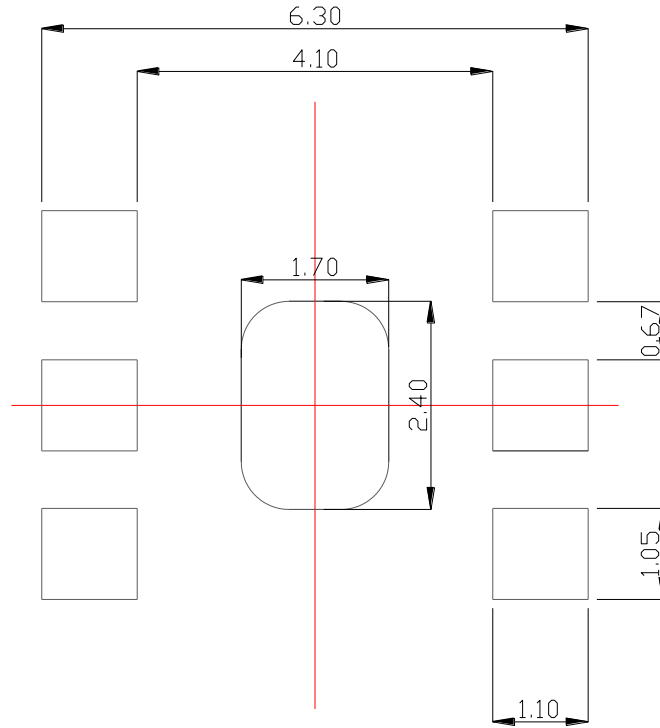
- (1) Quantity : 1200pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ±0.2mm
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package

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8. Recommended solder pad



Notes :

- [1] All dimensions are in millimeters.
- [2] Scale : none
- [3] Undefined tolerance is $\pm 0.1\text{mm}$
This drawing without tolerances are for reference only